

- Designed for Interactive Video Applications
- Wide Bandwidth and Excellent GD Variation
- 9.1 x 7.1 mm Surface-mount Case
- Single Ended Input and Output
- Complies with Directive 2002/95/EC (RoHS)

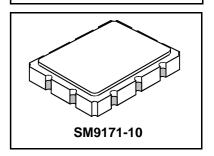


Absolute Maximum Ratings

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Rating	Value	Units			
Maximum Incident Power in Passband	+10	dBm			
Max. DC voltage between any 2 terminals	30	VDC			
Storage Temperature Range	-40 to +85	°C			
Suitable for lead-free soldering - Max. Soldering Profile	260°C	for 30 s			

SF1126A

127 MHz SAW Filter



Electrical Characteristics

Characteristic			Notes	Min	Тур	Max	Units
Nominal Center F	requency	f _C	1		127.000		MHz
Passband	Insertion Loss at fc	IL			14	15.0	dB
	1.3 db Passband	BW _{1.3}		±15.0			MHz
	Group Delay Variation over fc ±fc12.0 MHz	GDV	1, 2		11	30	ns _{P-P}
	Phase Linearity over fc±12.0 MHz					10	°P-P
Rejection	< 107.0 MHz			40			
	> 147.25 MHz		1, 2, 3	40			dB
	Ultimate				40		
Operating Temperature Range		T _A	1	+25		+30	°C
Frequency Temperature Coefficient		FTC	ļ ļ		-94		ppm/°C

Impedance Matching to 50Ω Unbalanced	External L-C
Case Style	SM9171-10 9.1 x 7.1 mm Nominal Footprint
Lid Symbolization (YY = year, WW = week)	RFM SF1126A YYWW

Notes

- 1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer.
- 2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.
- Rejection is measured as attenuation below the minimum IL point in the passband.
 Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
- Part to part absolute delay measurement records the absolute delay mean across 1 dB passband.
- 5. "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
- 6. The design, manufacturing process, and specifications of this filter are subject to change.
- Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
- 8. US and international patents may apply.
- 9. Electrostatic Sensitive Device. Observe precautions for handling.



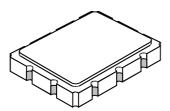
Electrical Connections

Connection	Terminals
Port 1 Hot (Input)	1
Port 1 Gnd Return	10
Port 2 Hot (Output)	6
Port 2 Gnd Return	5
Case Ground	All others

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SM9171-10 Case

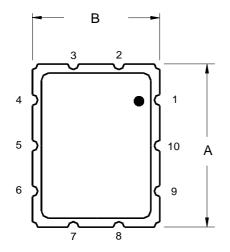
10-Terminal Ceramic Surface-Mount Case 9.1 x 7.1 mm Nominal Footprint

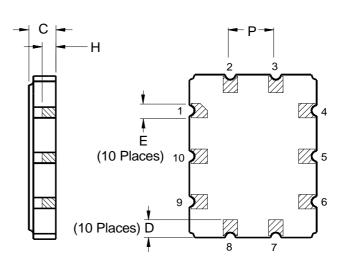


Case Dimensions						
Dimension	mm			Inches		
Dilliension	Min	Nom	Max	Min	Nom	Max
Α	8.86	9.09	9.40	0.349	0.358	0.370
В	6.88	7.11	7.40	0.271	0.280	0.291
С		1.91	2.00		0.075	0.079
D		0.99			0.039	
E		0.79			0.031	
Н		1.0			0.039	
Р		2.54			0.100	

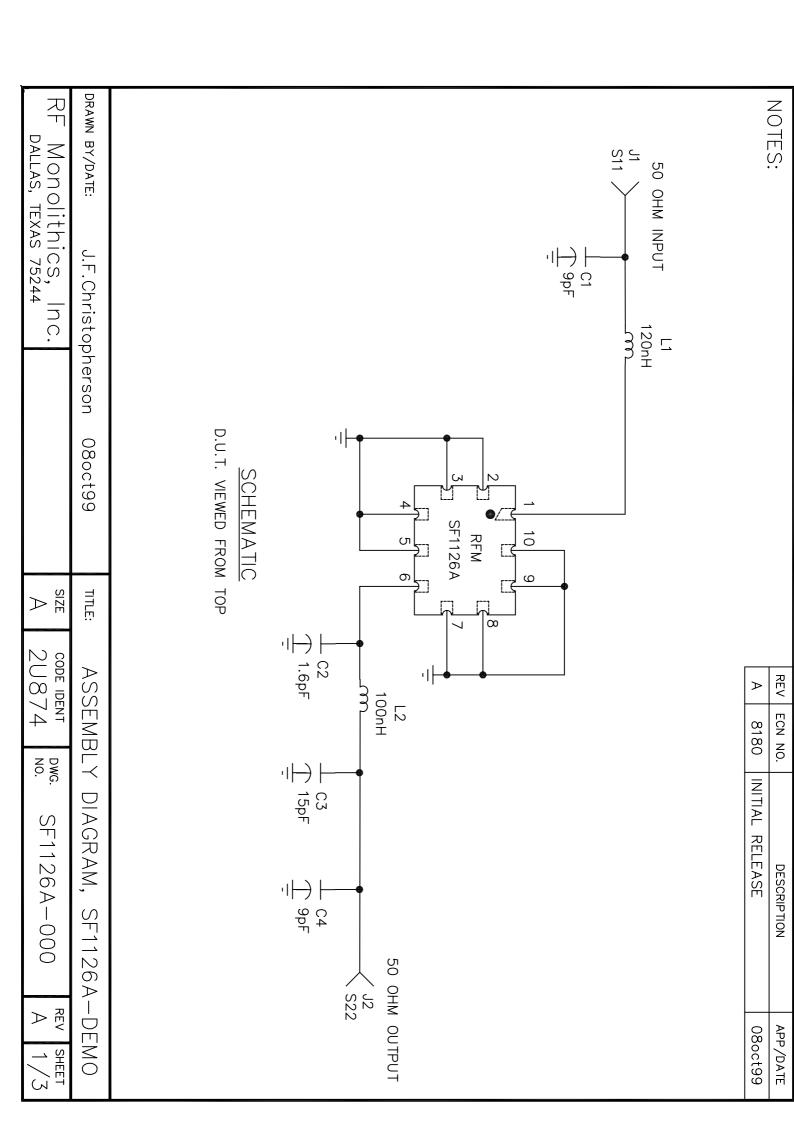
Materials				
Solder Pad Termination	Au plating 30 - 60 μinches (76.2-152 μm) over 80-200 μinches (203-508 μm) Ni.			
Lid	Fe-Ni-Co Alloy Electroless Nickel Plate (8-11% Phosphorus) 100-200 µinches Thick			
Body	Al ₂ O ₃ Ceramic			
Pb Free				

Electrical Connections				
	Connection	Terminals		
Port 1	Input or Return	6		
	Return or Input	5		
Port 2	Output or Return	1		
	Return or Output	10		
	Ground	All others		
Single	Ended Operation	Return is ground		
Differe	ntial Operation	Return is hot		



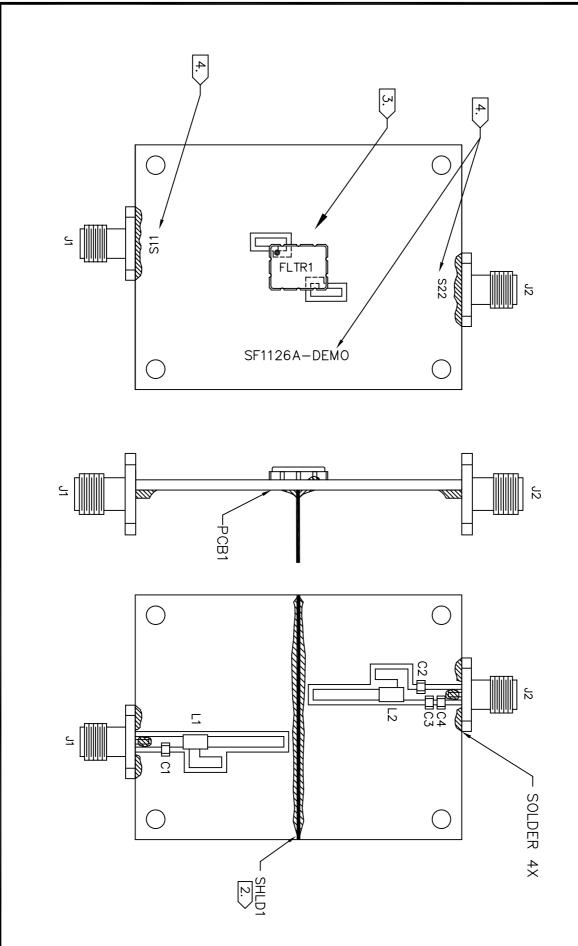


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NOTES:

- SOLDER MOUNT COMPONENTS AND CONNECTORS TO PCB1
 > SOLDER SHLD1 AS SHOWN AND TRIM TAB FROM SHIELD SO THAT IT IS FLUSH WITH PCB.
- ORIENT THE FLTR1 AND SOLDER IT DOWN TO THE BOARD AS SHOWN
- LABEL AS SHOWN.



꾸 DALLAS, TEXAS 75244 Monolithics, Inc.

SIZE CODE IDENT

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DWG. SF1126A-000

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